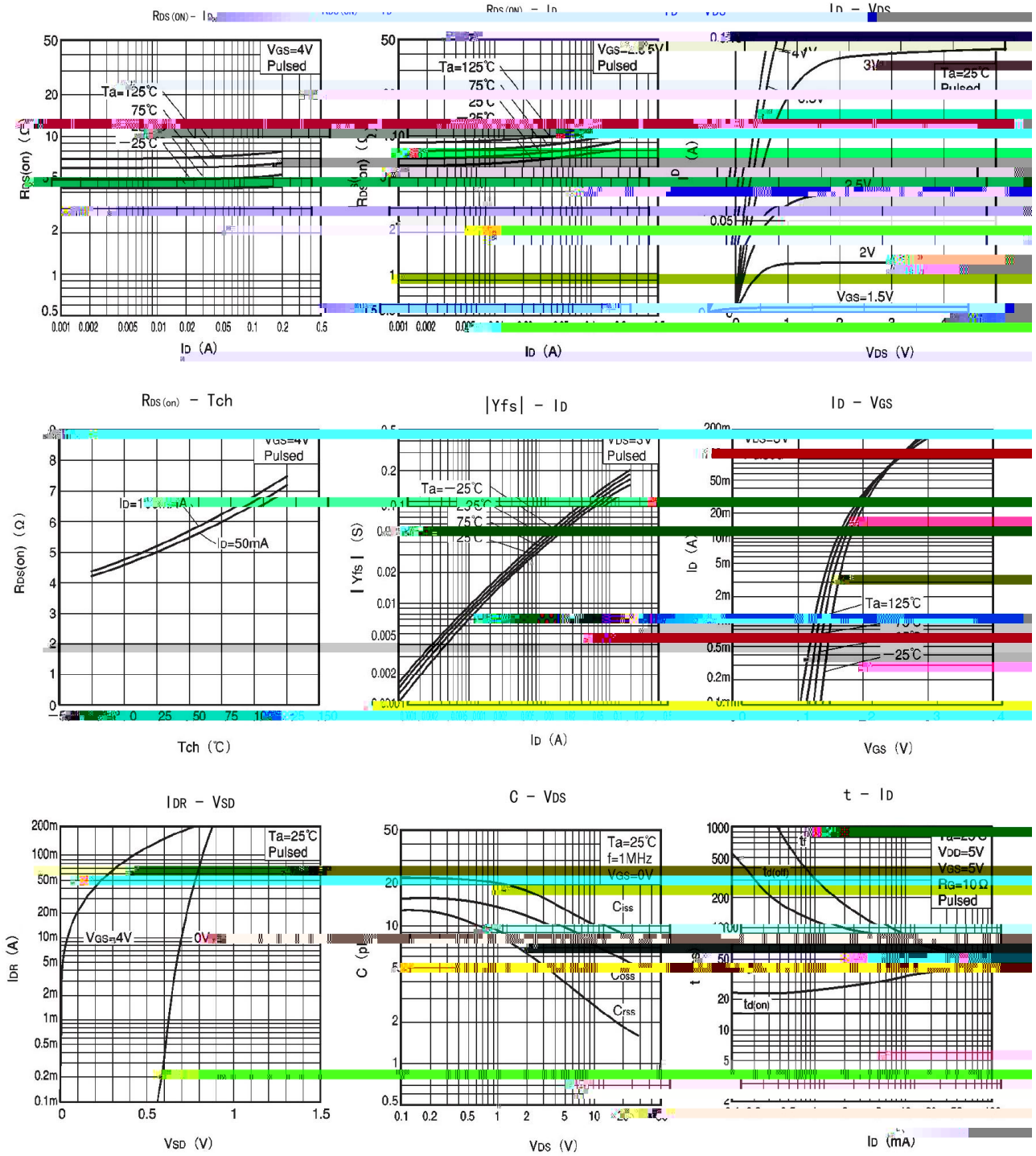


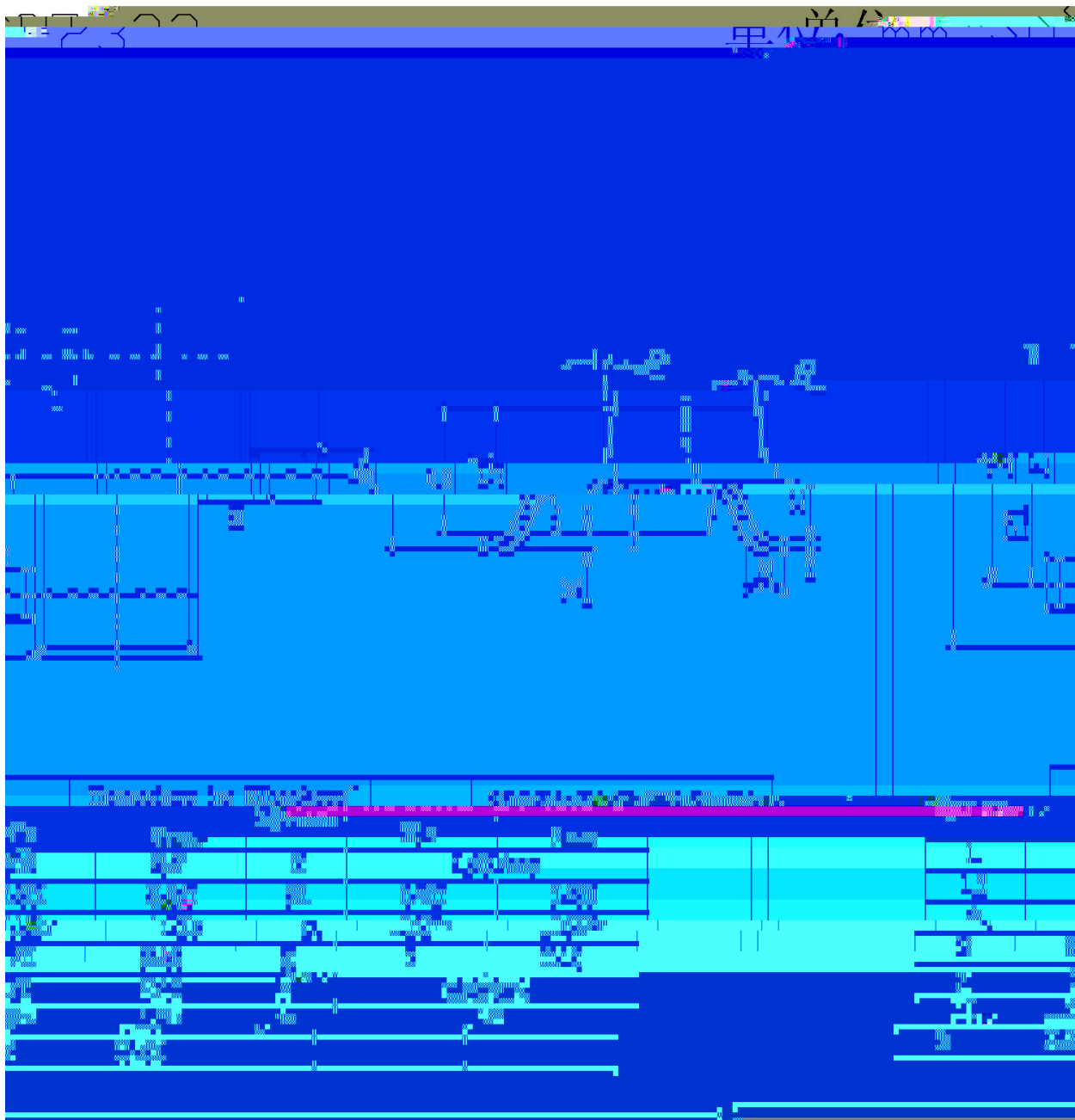




/ Electrical Characteristic Curve

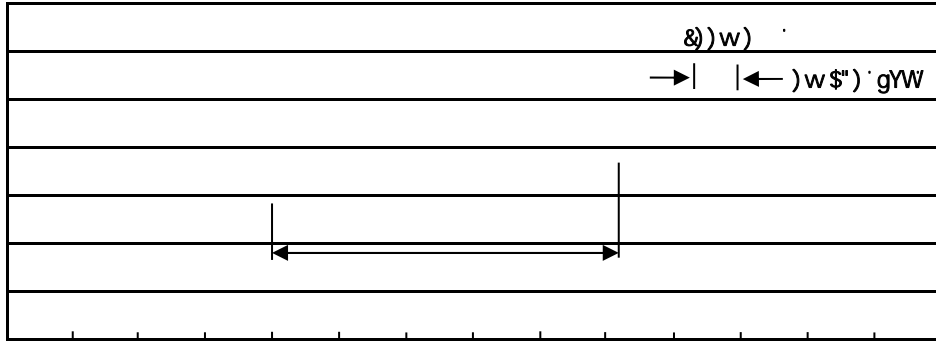


/ Package Dimensions





**( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)**



**Note:**

- 1            150 200            60 120sec;      1.Preheating:150~200 , Time:60~120sec.
- 2            255±5                    5±0.5sec;      2.Peak Temp.:255±5 , Duration:5±0.5sec.
- 3                            2 10 /sec.            3. Cooling Speed: 2~10 /sec.

**/ Resistance to Soldering Heat Test Conditions**

260±5                    10±1 sec.                    Temp.:260±5                    Time:10±1 sec

**/ Packaging SPEC.**

**/ REEL**

Package Type	Units					Dimension (unit mm <sup>3</sup> )		
	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box
SOT-23	3,000	10	30,000	6	180,000	7 ×8	180×120×180	390×385×205

**/ Notices**